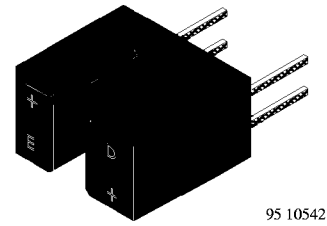
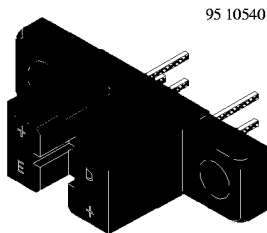


## Optoelectronic Interrupter without Aperture

### Description

This device has a compact construction where the emitting-light sources and the detectors are located face-to-face on the same optical axis.

The operating wavelength is 950 nm. The detector consists of a phototransistor.



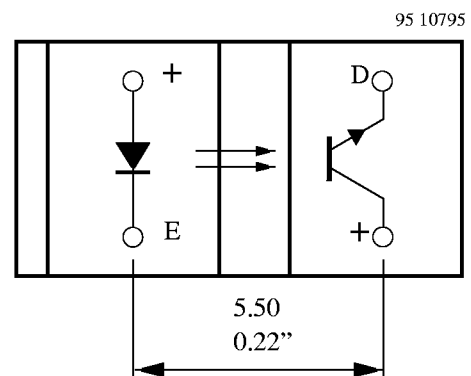
### Applications

Contactless optoelectronic switch, control and counter

### Features

- Compact construction
- No setting efforts
- 2 case variations
- Polycarbonate case protected against ambient light

### Pin Connections



## Absolute Maximum Ratings

### Input (Emitter)

Parameters	Test Conditions	Symbol	Value	Unit
Reverse voltage		$V_R$	6	V
Forward current		$I_F$	60	mA
Forward surge current	$t_p \leq 10 \mu s$	$I_{FSM}$	3	A
Power dissipation	$T_{amb} \leq 25^\circ C$	$P_V$	100	mW
Junction temperature		$T_j$	100	$^\circ C$

### Output (Detector)

Parameters	Test Conditions	Symbol	Value	Unit
Collector emitter voltage		$V_{CEO}$	70	V
Emitter collector voltage		$V_{ECO}$	7	V
Collector current		$I_C$	100	mA
Collector peak current	$t_p/T = 0.5, t_p \leq 10 ms$	$I_{CM}$	200	mA
Power dissipation	$T_{amb} \leq 25^\circ C$	$P_V$	150	mW
Junction temperature		$T_j$	100	$^\circ C$

### Coupler

Parameters	Test Conditions	Symbol	Value	Unit
Total power dissipation	$T_{amb} \leq 25^\circ C$	$P_{tot}$	250	mW
Ambient temperature range		$T_{amb}$	-55 to +85	$^\circ C$
Storage temperature range		$T_{stg}$	-55 to +100	$^\circ C$
Soldering temperature, maximal	2 mm from case, $t \leq 5 s$	$T_{sd}$	260	$^\circ C$

## Electrical Characteristics

$T_{amb} = 25^{\circ}\text{C}$

### Input (Emitter)

Parameters	Test Conditions	Type	Symbol	Min.	Typ.	Max.	Unit
Forward voltage	$I_F = 60 \text{ mA}$		$V_F$		1.25	1.5	V
Junction capacitance	$V_R = 0,$ $f = 1 \text{ MHz}$		$C_j$		50		pF

### Output (Detector)

Parameters	Test Conditions	Type	Symbol	Min.	Typ.	Max.	Unit
Collector emitter voltage	$I_C = 1 \text{ mA}$		$V_{CEO}$	70			V
Emitter collector voltage	$I_E = 10 \mu\text{A}$		$V_{ECO}$	7			V
Collector dark current	$V_{CE} = 25 \text{ V},$ $I_F = 0, E = 0$		$I_{CEO}$			100	nA

### Coupler

Parameters	Test Conditions	Type	Symbol	Min.	Typ.	Max.	Unit
Current transfer ratio	$V_{CE} = 5 \text{ V},$ $I_F = 20 \text{ mA}$	TCST1000, TCST2000	CTR	1.25	2.5		%
Collector current	$V_{CE} = 5 \text{ V},$ $I_F = 20 \text{ mA}$	TCST1000, TCST2000	$I_C$	0.25	0.5		mA
Collector emitter saturation voltage	$I_F = 20 \text{ mA},$ $I_C = 25 \mu\text{A}$		$V_{CEsat}$			0.4	V
Resolution, path of the shutter crossing the radiant sensitive zone	$I_{Crel} = 10/90\%$		s		0.6		mm

## Switching Characteristics

$V_S = 5\text{ V}$ ,  $I_C = 1\text{ mA}$ ,  $R_L = 100\ \Omega$

Parameters	Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Turn-on time		$t_{on}$		15		$\mu\text{s}$
Turn-off time		$t_{off}$		10		$\mu\text{s}$

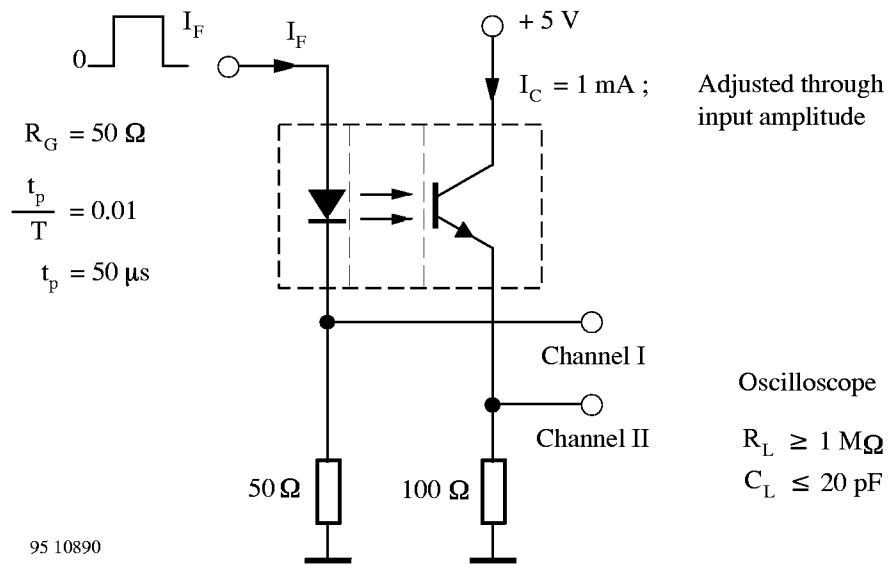


Figure 1. Test circuit

**Typical Characteristics** ( $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified)

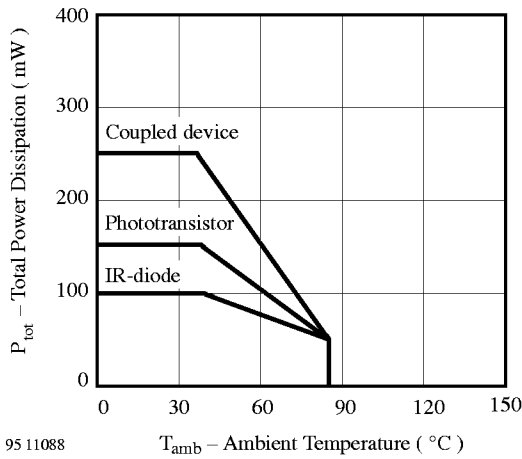


Figure 2. Total Power Dissipation vs. Ambient Temperature

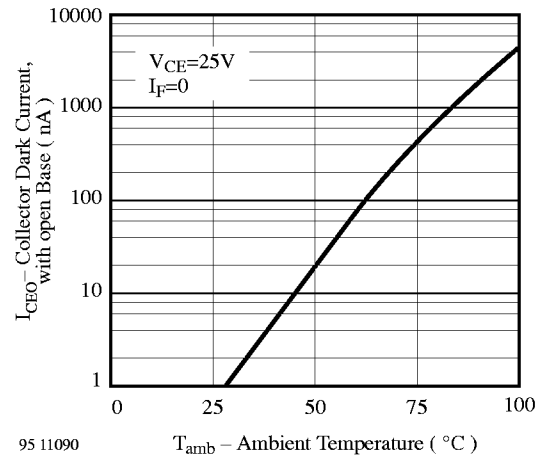


Figure 5. Collector Dark Current vs. Ambient Temperature

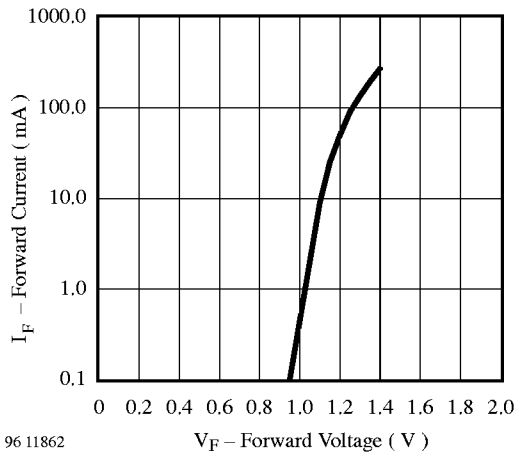


Figure 3. Forward Current vs. Forward Voltage

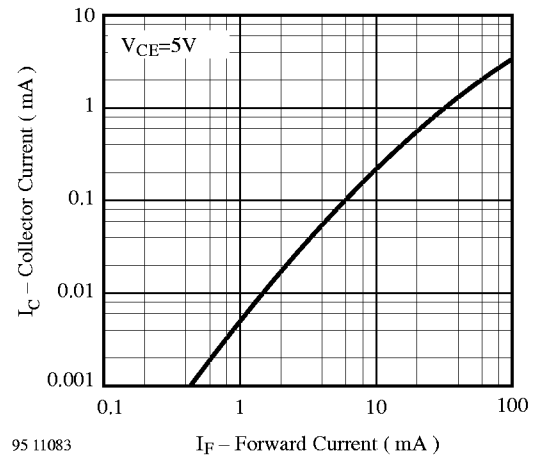


Figure 6. Collector Current vs. Forward Current

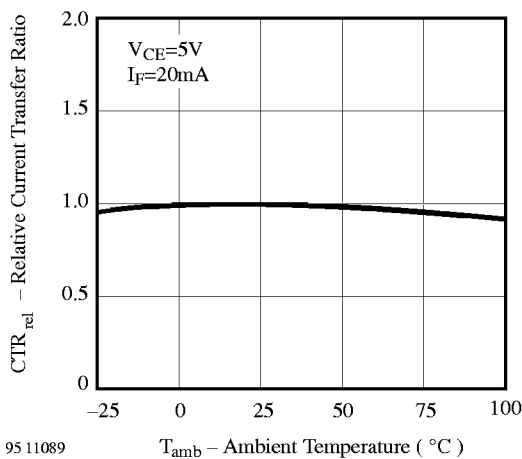


Figure 4. Rel. Current Transfer Ratio vs. Ambient Temperature

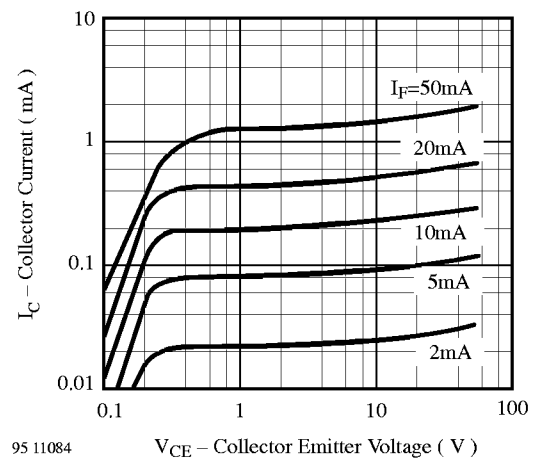


Figure 7. Collector Current vs. Collector Emitter Voltage

## Typical Characteristics ( $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified)

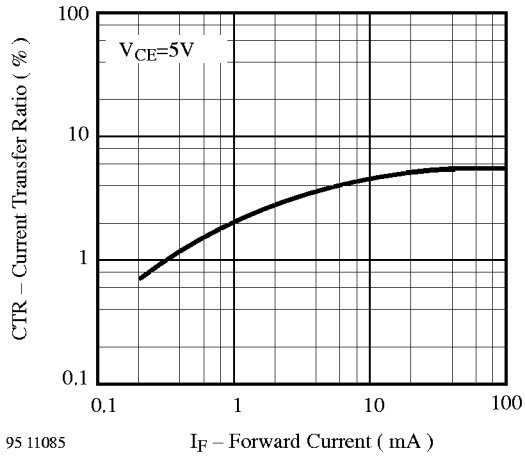


Figure 8. Current Transfer Ratio vs. Forward Current

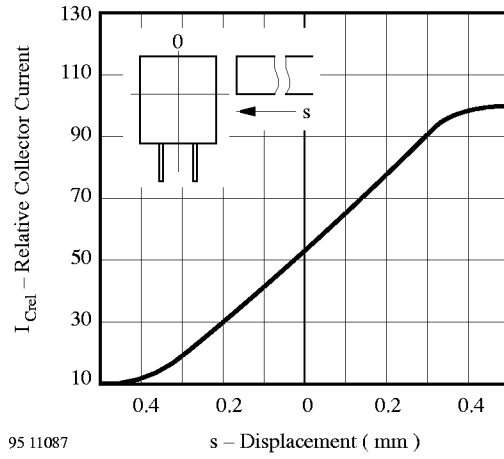


Figure 10. Relative Collector Current vs. Displacement

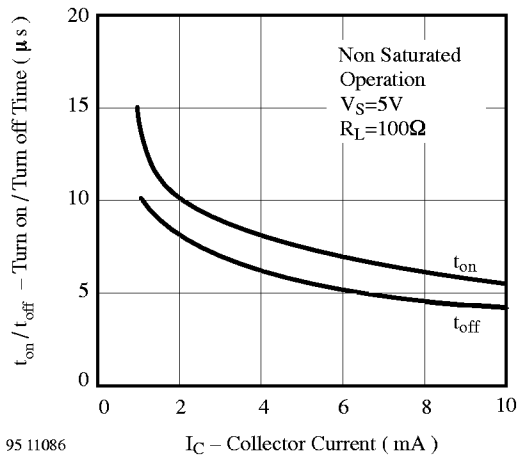
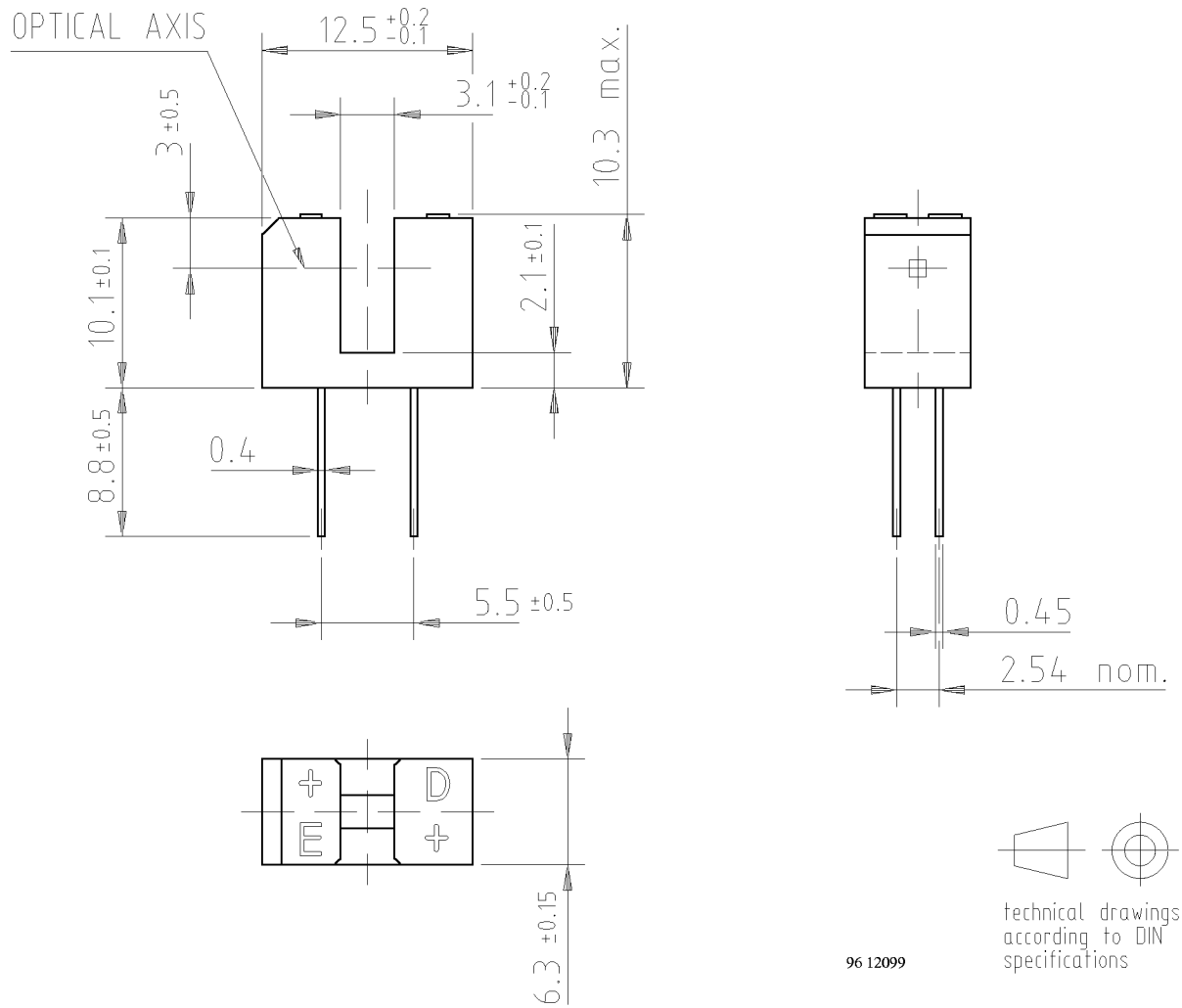


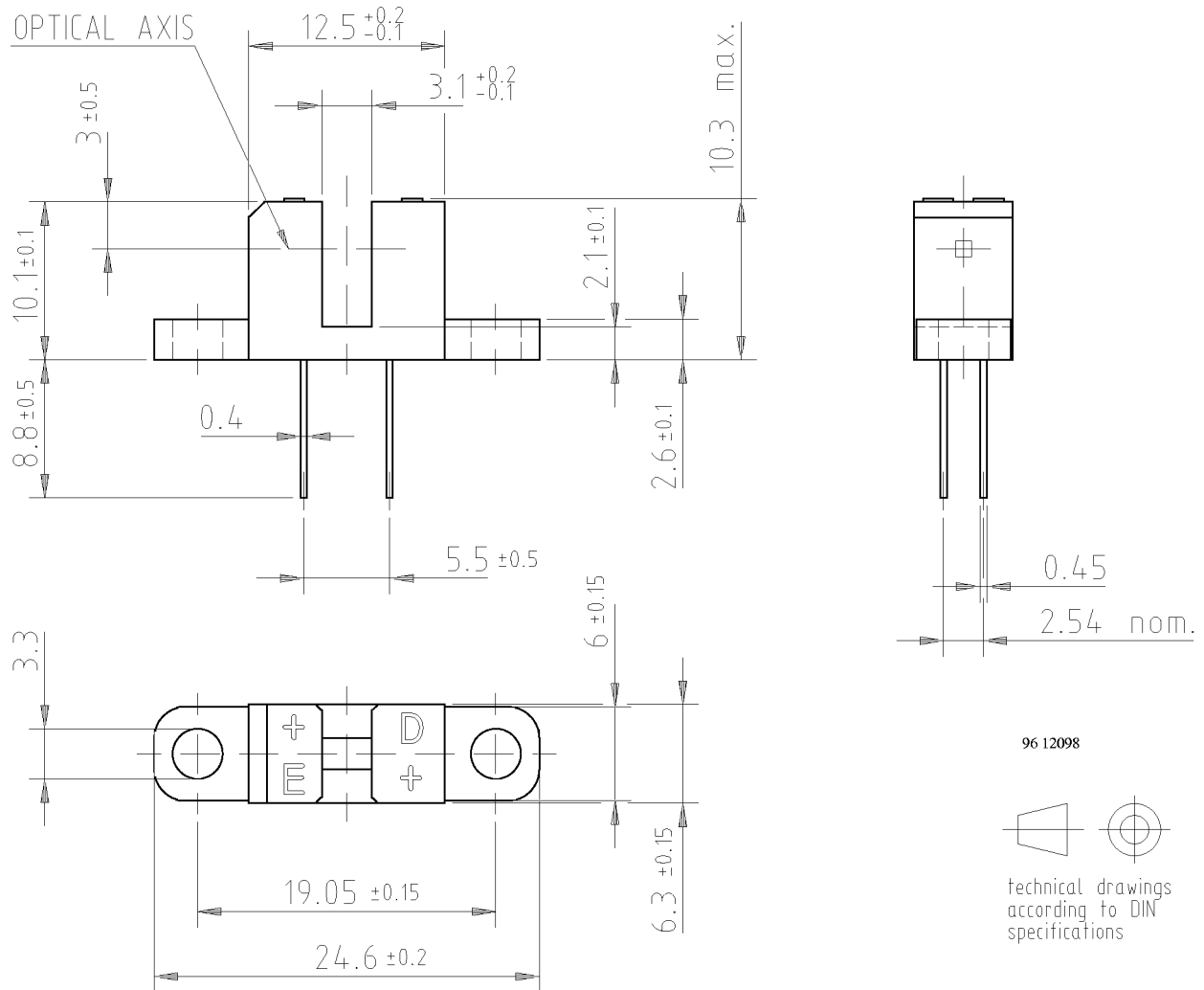
Figure 9. Turn on / off Time vs. Collector Current

**Dimensions of TCST1000 in mm**



weight: ca. 0.80 g

## Dimensions of TCST2000 in mm



weight: ca. 0.90 g

## Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**TEMIC TELEFUNKEN microelectronic GmbH** semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**TEMIC** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

**We reserve the right to make changes to improve technical design and may do so without further notice.**

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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